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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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HD74ALVC1G125

Bus Buffer Gate with 3-state Output

REJ03D0129–0300Z
(Previous ADE-205-617B (Z))
Rev.3.00
Nov.12.2003

Description

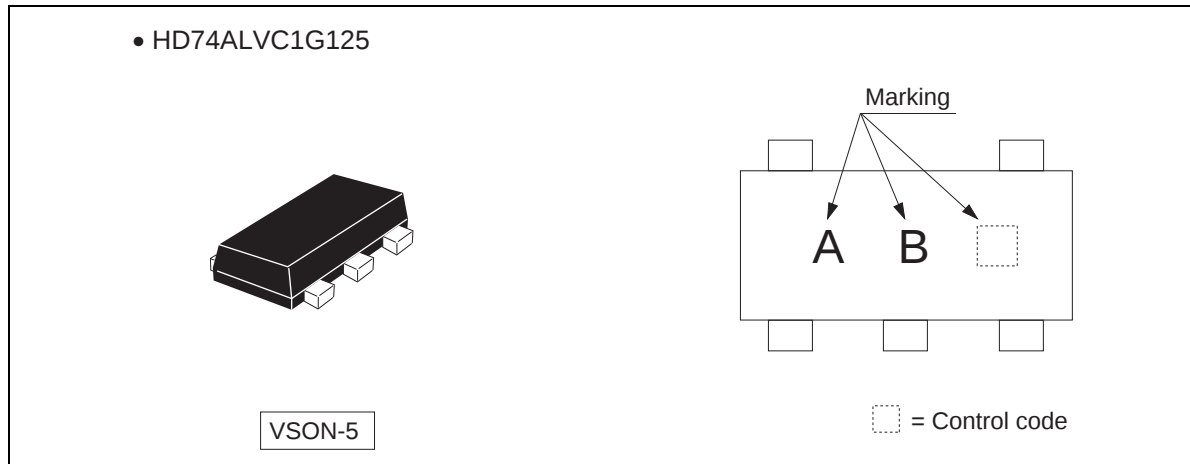
The HD74ALVC1G125 has a bus buffer gate with 3-state output in a 5 pin package. Output is disabled when the associated output enable ($\overline{OE}$) input is high. To ensure the high impedance state during power up or power down, $\overline{OE}$ should be connected to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current sinking capability of the driver. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Supply voltage range : 1.2 to 3.6 V
Operating temperature range : -40 to $+85^{\circ}\text{C}$
- All inputs V_{IH} (Max.) = 3.6 V (@ V_{CC} = 0 V to 3.6 V)
All outputs V_O (Max.) = 3.6 V (@ V_{CC} = 0 V)
- Output current ± 2 mA (@ V_{CC} = 1.2 V)
 ± 4 mA (@ V_{CC} = 1.4 V to 1.6 V)
 ± 6 mA (@ V_{CC} = 1.65 V to 1.95 V)
 ± 18 mA (@ V_{CC} = 2.3 V to 2.7 V)
 ± 24 mA (@ V_{CC} = 3.0 V to 3.6 V)
- Ordering Information

Part Name	Package Type	Package Code	Package	Taping Abbreviation
			Abbreviation	(Quantity)
HD74ALVC1G125VSE	VSON-5 pin	TNP-5DV	VS	E (3,000 pcs/reel)

Outline and Article Indication

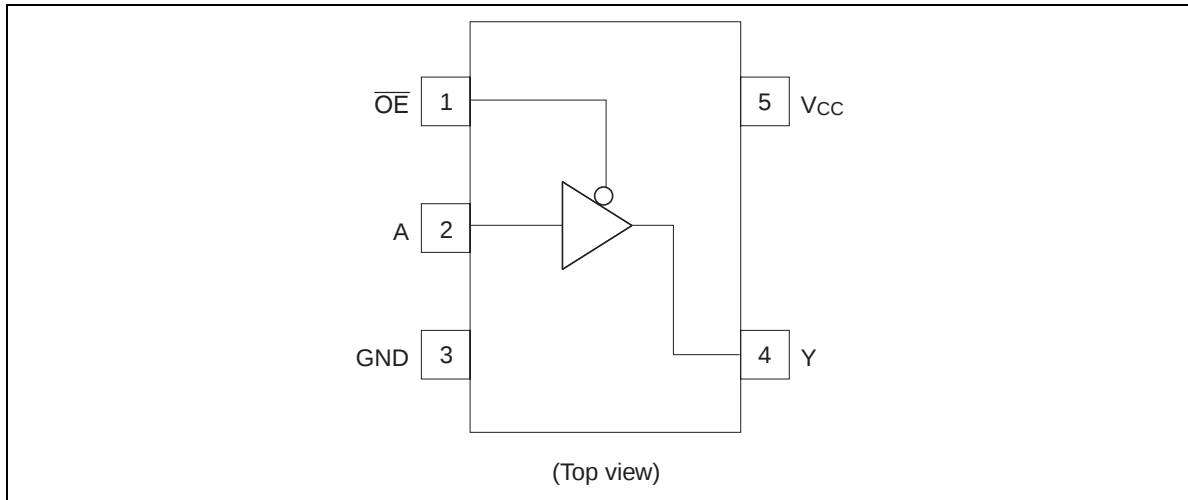


Function Table

Inputs		Output Y
$\overline{OE}$	A	
L	H	H
L	L	L
H	X	Z

H: High level
 L: Low level
 X: Immaterial
 Z: High impedance

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V_{CC}	-0.5 to 4.6	V	
Input voltage range ^{*1}	V_I	-0.5 to 4.6	V	
Output voltage range ^{*1, 2}	V_O	-0.5 to $V_{CC}+0.5$	V	Output : H or L or Z
		-0.5 to 4.6		V_{CC} : OFF
Input clamp current	I_{IK}	-50	mA	$V_I < 0$
Output clamp current	I_{OK}	± 50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I_O	± 50	mA	$V_O = 0$ to V_{CC}
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	± 100	mA	
Maximum power dissipation at $T_a = 25^\circ\text{C}$ (in still air) ^{*3}	P_T	200	mW	
Storage temperature	T_{stg}	-65 to 150	$^\circ\text{C}$	

- Notes:
- The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.
 - 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. This value is limited to 4.6 V maximum.
 - 3. The maximum package power dissipation was calculated using a junction temperature of 150°C .

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V_{CC}	1.2	3.6	V	
Input voltage range	V_I	0	3.6	V	
Output voltage range	V_O	0	V_{CC}	V	
Output current	I_{OH}	—	−2	mA	$V_{CC} = 1.2\text{ V}$
		—	−4		$V_{CC} = 1.4\text{ V}$
		—	−6		$V_{CC} = 1.65\text{ V}$
		—	−18		$V_{CC} = 2.3\text{ V}$
		—	−24		$V_{CC} = 3.0\text{ V}$
	I_{OL}	—	2		$V_{CC} = 1.2\text{ V}$
		—	4		$V_{CC} = 1.4\text{ V}$
		—	6		$V_{CC} = 1.65\text{ V}$
		—	18		$V_{CC} = 2.3\text{ V}$
		—	24		$V_{CC} = 3.0\text{ V}$
Input transition rise or fall rate	$\Delta t / \Delta v$	0	20	ns / V	$V_{CC} = 1.2\text{ to }2.7\text{ V}$
		0	10		$V_{CC} = 3.3\pm 0.3\text{ V}$
Operating free-air temperature	T_a	−40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

(T_a = -40 to 85°C)

Item	Symbol	V _{CC} (V) *	Min	Typ	Max	Unit	Test conditions
Input voltage	V _{IH}	1.2	V _{CC} ×0.75	—	—	V	
		1.4 to 1.6	V _{CC} ×0.7	—	—		
		1.65 to 1.95	V _{CC} ×0.7	—	—		
		2.3 to 2.7	1.7	—	—		
		3.0 to 3.6	2.0	—	—		
	V _{IL}	1.2	—	—	V _{CC} ×0.25		
		1.4 to 1.6	—	—	V _{CC} ×0.3		
		1.65 to 1.95	—	—	V _{CC} ×0.3		
		2.3 to 2.7	—	—	0.7		
		3.0 to 3.6	—	—	0.8		
Output voltage	V _{OH}	Min to Max	V _{CC} -0.2	—	—	V	I _{OH} = -100 μA
		1.2	0.9	—	—		I _{OH} = -2 mA
		1.4	1.1	—	—		I _{OH} = -4 mA
		1.65	1.2	—	—		I _{OH} = -6 mA
		2.3	1.7	—	—		I _{OH} = -18 mA
		3.0	2.2	—	—		I _{OH} = -24 mA
	V _{OL}	Min to Max	—	—	0.2		I _{OL} = 100 μA
		1.2	—	—	0.3		I _{OL} = 2 mA
		1.4	—	—	0.3		I _{OL} = 4 mA
		1.65	—	—	0.3		I _{OL} = 6 mA
		2.3	—	—	0.55		I _{OL} = 18 mA
		3.0	—	—	0.55		I _{OL} = 24 mA
Input current	I _{IN}	3.6	—	—	±5	μA	V _{IN} = 3.6 V or GND
Off state output current	I _{OZ}	3.6	—	—	±5	μA	V _O = V _{CC} or GND
Quiescent supply current	I _{CC}	3.6	—	—	10	μA	V _{IN} = V _{CC} or GND, I _O = 0
Output leakage current	I _{OFF}	0	—	—	5	μA	V _{IN} or V _O = 0 to 3.6 V
Input capacitance	C _{IN}	3.3	—	4.0	—	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

HD74ALVC1G125

Switching Characteristics

(Ta = -40 to 85°C)

V_{CC} = 1.2 V

Item	Symbol	Min	Typ	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	—	5.5	—	ns	C _L = 15 pF	A	Y
Enable time	t _{ZH} t _{ZL}	—	6.5	—	ns	C _L = 15 pF	$\overline{\text{OE}}$	Y
Disable time	t _{HZ} t _{LZ}	—	4.5	—	ns	C _L = 15 pF	$\overline{\text{OE}}$	Y

V_{CC} = 1.5±0.1 V

Item	Symbol	Min	Typ	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	2.0	—	7.0	ns	C _L = 15 pF	A	Y
Enable time	t _{ZH} t _{ZL}	2.0	—	7.0	ns	C _L = 15 pF	$\overline{\text{OE}}$	Y
Disable time	t _{HZ} t _{LZ}	2.0	—	7.0	ns	C _L = 15 pF	$\overline{\text{OE}}$	Y

V_{CC} = 1.8±0.15 V

Item	Symbol	Min	Typ	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	1.5	—	5.0	ns	C _L = 30 pF	A	Y
Enable time	t _{ZH} t _{ZL}	1.5	—	5.0	ns	C _L = 30 pF	$\overline{\text{OE}}$	Y
Disable time	t _{HZ} t _{LZ}	1.5	—	5.0	ns	C _L = 30 pF	$\overline{\text{OE}}$	Y

HD74ALVC1G125

Switching Characteristics (cont)

$$V_{CC} = 2.5 \pm 0.2 \text{ V}$$

Item	Symbol	Min	Typ	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t_{PLH} t_{PHL}	1.0	—	4.0	ns	$C_L = 30 \text{ pF}$	A	Y
Enable time	t_{ZH} t_{ZL}	1.0	—	4.0	ns	$C_L = 30 \text{ pF}$	$\overline{OE}$	Y
Disable time	t_{HZ} t_{LZ}	1.0	—	4.0	ns	$C_L = 30 \text{ pF}$	$\overline{OE}$	Y

$$V_{CC} = 3.3 \pm 0.3 \text{ V}$$

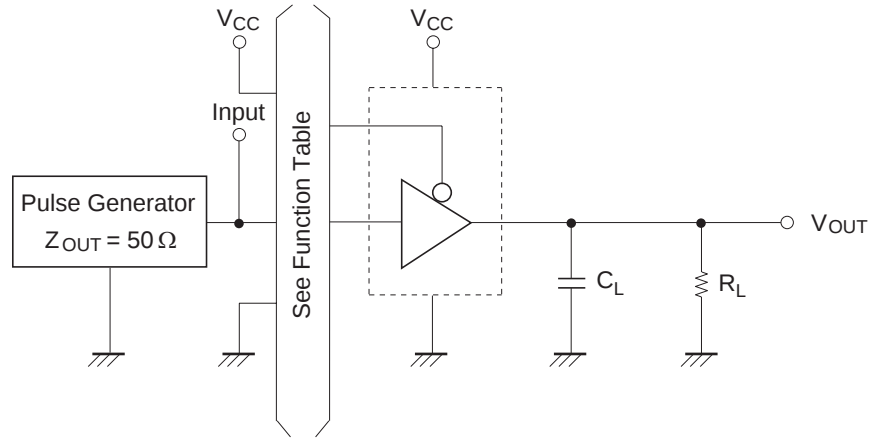
Item	Symbol	Min	Typ	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t_{PLH} t_{PHL}	1.0	—	3.0	ns	$C_L = 30 \text{ pF}$	A	Y
Enable time	t_{ZH} t_{ZL}	1.0	—	3.0	ns	$C_L = 30 \text{ pF}$	$\overline{OE}$	Y
Disable time	t_{HZ} t_{LZ}	1.0	—	3.0	ns	$C_L = 30 \text{ pF}$	$\overline{OE}$	Y

Operating Characteristics

$$(T_a = 25^\circ\text{C})$$

Item	Symbol	V_{CC} (V)	Min	Typ	Max	Unit	Test conditions
Power dissipation capacitance	C_{PD}	1.5	—	9.5	—	pF	$f = 10 \text{ MHz}$
		1.8	—	9.5	—		
		2.5	—	10.0	—		
		3.3	—	11.0	—		

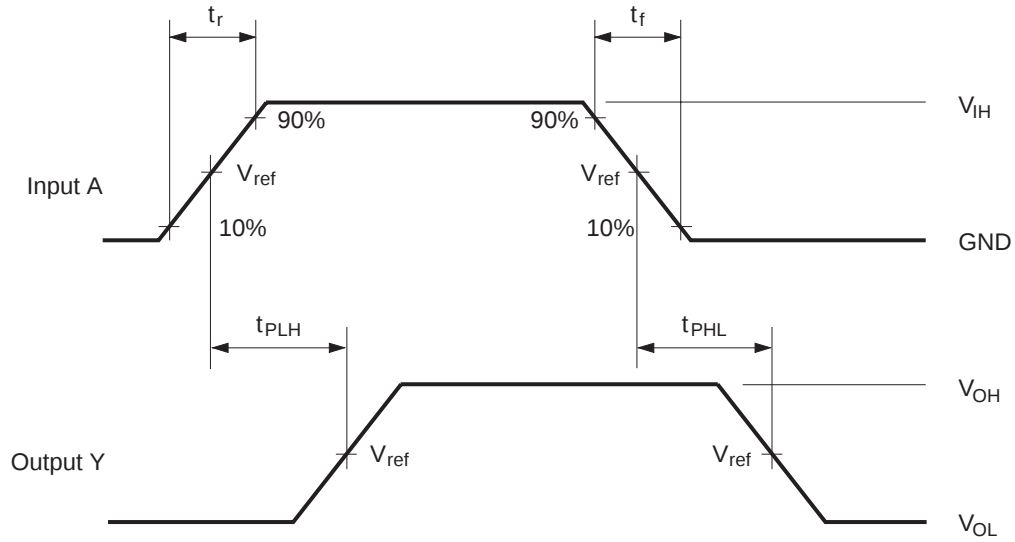
Test Circuit



Symbol	$V_{CC} = 1.2\text{ V},$ $1.5 \pm 0.1\text{ V}$	$V_{CC} = 1.8 \pm 0.15\text{ V}$	$V_{CC} = 2.5 \pm 0.2\text{ V},$ $3.3 \pm 0.3\text{ V}$
R_L	2.0 k Ω	1.0 k Ω	500 Ω
C_L	15 pF	30 pF	30 pF

Note: C_L includes probe and jig capacitance.

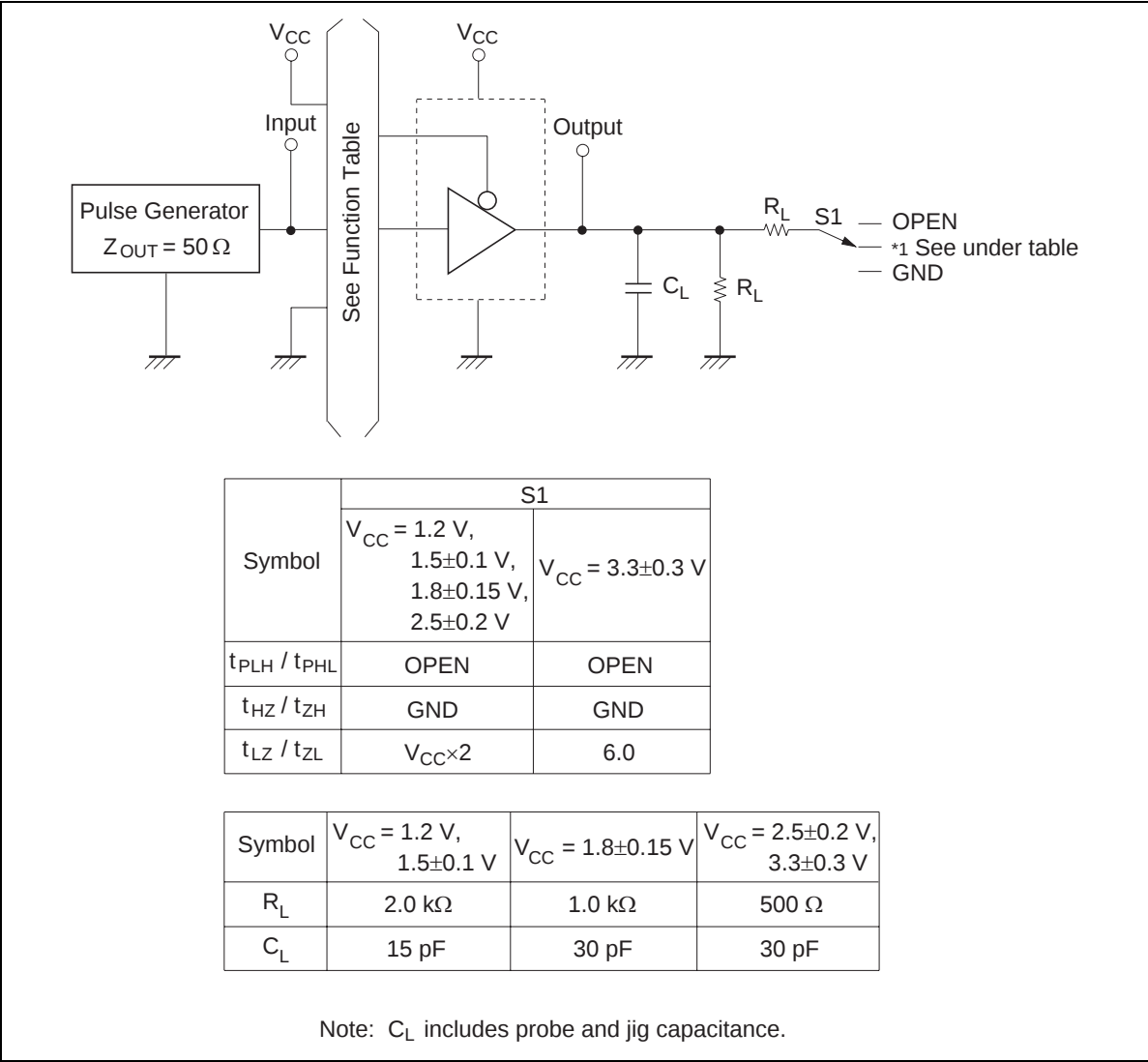
Waveforms



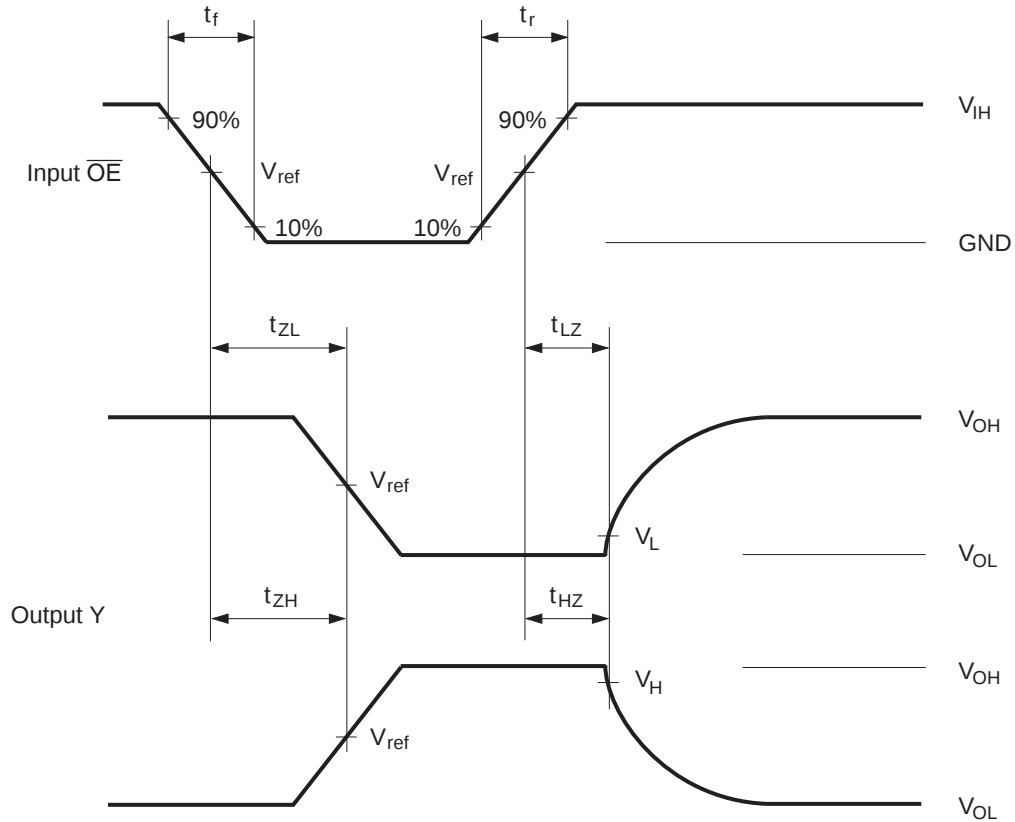
Symbol	$V_{CC} = 1.2\text{ V},$ $1.5 \pm 0.1\text{ V},$ $1.8 \pm 0.15\text{ V}$	$V_{CC} = 2.5 \pm 0.2\text{ V}$	$V_{CC} = 3.3 \pm 0.3\text{ V}$
t_r / t_f	2.0 ns	2.5 ns	2.5 ns
V_{IH}	V_{CC}	V_{CC}	2.7 V
V_{ref}	50%	50%	1.5 V

Note: Input waveform : PRR = 10 MHz, duty cycle 50%

Test Circuit



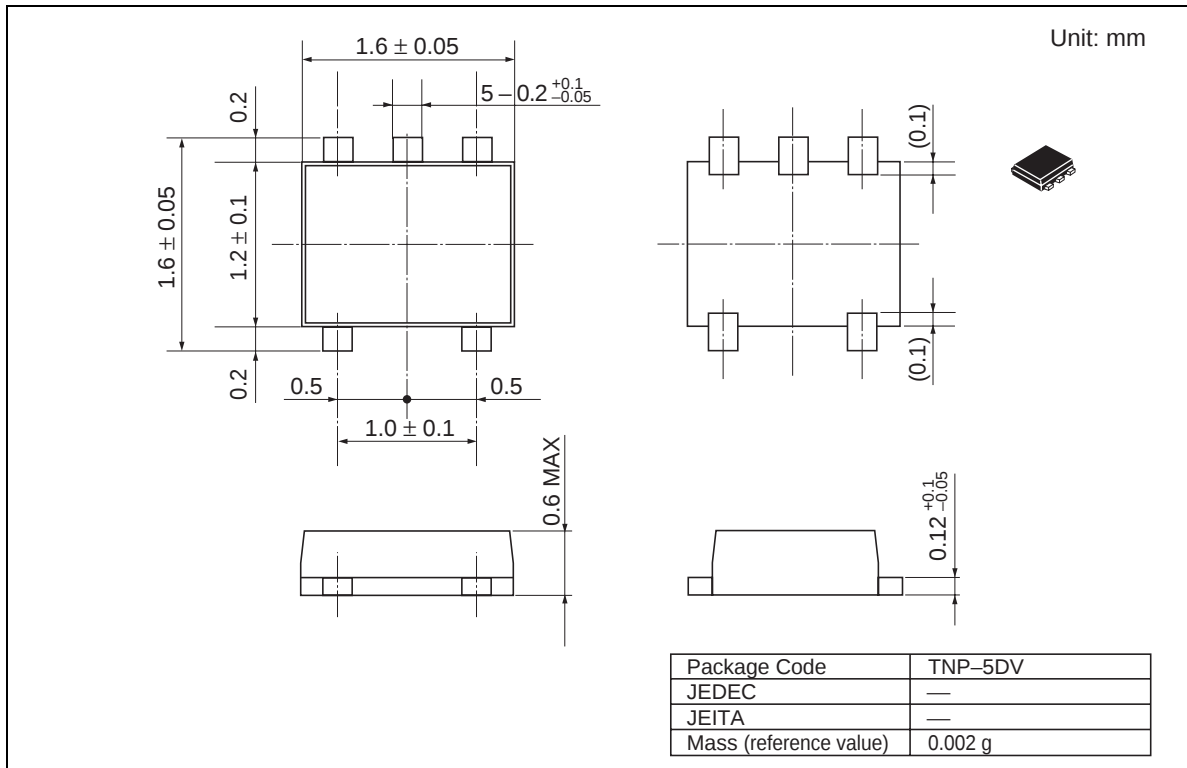
Waveforms



Symbol	$V_{CC} = 1.2 \text{ V},$ $1.5 \pm 0.1 \text{ V}$	$V_{CC} = 1.8 \pm 0.15 \text{ V}$	$V_{CC} = 2.5 \pm 0.2 \text{ V}$	$V_{CC} = 3.3 \pm 0.3 \text{ V}$
t_r / t_f	2.0 ns	2.0 ns	2.5 ns	2.5 ns
V_{IH}	V_{CC}	V_{CC}	V_{CC}	2.7 V
V_{ref}	50%	50%	50%	1.5 V
V_H / V_L	$V_H = V_{OH} - 0.1 \text{ V}$ $V_L = V_{OL} + 0.1 \text{ V}$	$V_H = V_{OH} - 0.15 \text{ V}$ $V_L = V_{OL} + 0.15 \text{ V}$	$V_H = V_{OH} - 0.15 \text{ V}$ $V_L = V_{OL} + 0.15 \text{ V}$	$V_H = V_{OH} - 0.3 \text{ V}$ $V_L = V_{OL} + 0.3 \text{ V}$

Note: Input waveform : PRR = 10 MHz, duty cycle 50%

Package Dimensions



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